

Schottky Rectifier Diodes

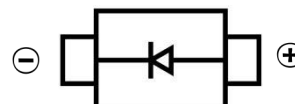
FEATURES

- Small Surface Mount device
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability


SMB

MECHANICAL DATA

- Case: SMB(DO-214AA)
- Case Material: Molded Plastic. UL flammability
- Classification Rating: 94V-0
- Weight: 0.088 grams (approximate)
- Marking: 10BQ100



MAXIMUM RATINGS AND CHARACTERISTICS($T_A = 25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	100	V
DC Reverse Voltage	V_R	100	V
RMS Reverse Voltage	V_{RMS}	70	V
Non-Repetitive Peak Forward Surge Current	I_{FSM}	780	A
		38	
Mean rectifying current	I_F	1	A
Repetitive Avalanche Current	I_{AR}	0.5	A
Non- Repetitive Avalanche Energy ($I_{AS} = 1\text{A}$, $L = 4\text{mH}$)	E_{AS}	1.0	mJ
Thermal Resistance From Junction To Ambient	$R_{\theta JA}$	80	$^{\circ}\text{C/W}$
Thermal Resistance From Junction To Lead	$R_{\theta JL}$	36	$^{\circ}\text{C/W}$
Junction and Storage Temperature	T_J, T_{STG}	-55 ~+150	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Forward voltage (Note1)	V_F			0.78	V	$I_F=1\text{A}, T_J=25^{\circ}\text{C}$
				0.89		$I_F=2\text{A}, T_J=25^{\circ}\text{C}$
				0.62		$I_F=1\text{A}, T_J=125^{\circ}\text{C}$
				0.72		$I_F=2\text{A}, T_J=125^{\circ}\text{C}$
Reverse current (Note1)	I_R			0.5	mA	$V_R=100\text{V}, T_J=25^{\circ}\text{C}$
				1.0		$V_R=100\text{V}, T_J=125^{\circ}\text{C}$
Junction capacitance	C_J		42		pF	$V_R=5\text{V}_{DC}, f=100\text{kHz} \sim 1\text{MHz}$
Typical Series Inductance	L_s		2.0		nH	
Volatqe Rate of Charge	dv/dt			10000	V/ μs	

Notes: 1. Pulse with $<300\ \mu\text{s}$, Duty Cycle $<2\%$

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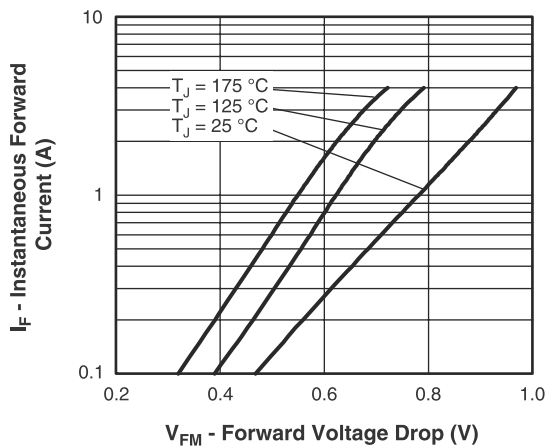


Fig. 1 - Maximum Forward Voltage Drop Characteristics

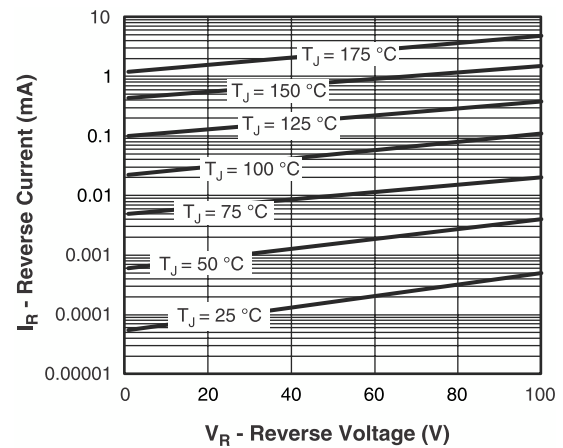


Fig. 2 - Typical Peak Reverse Current vs. Reverse Voltage

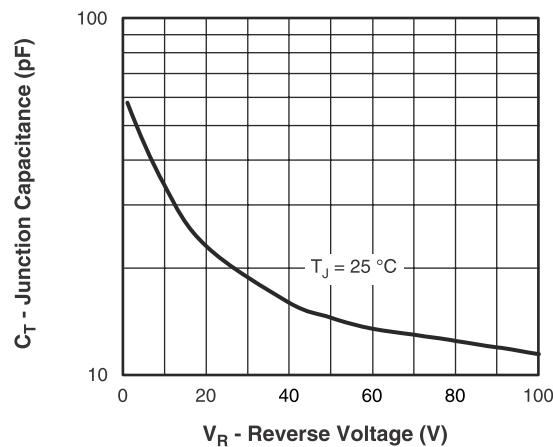


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

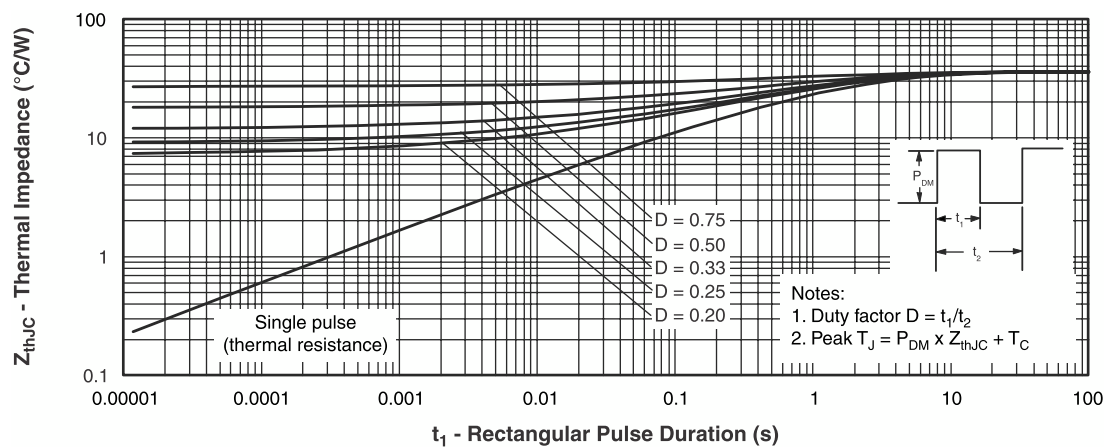


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

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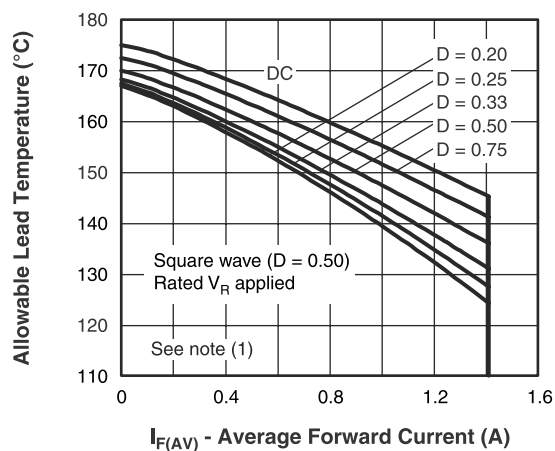


Fig. 5 - Maximum Average Forward Current vs. Allowable Lead Temperature

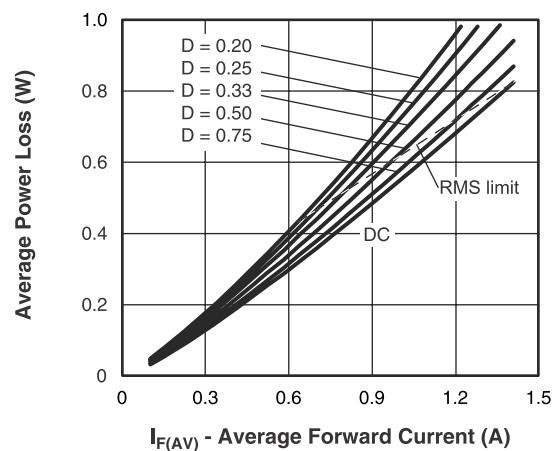


Fig. 6 - Maximum Average Forward Dissipation vs. Average Forward Current

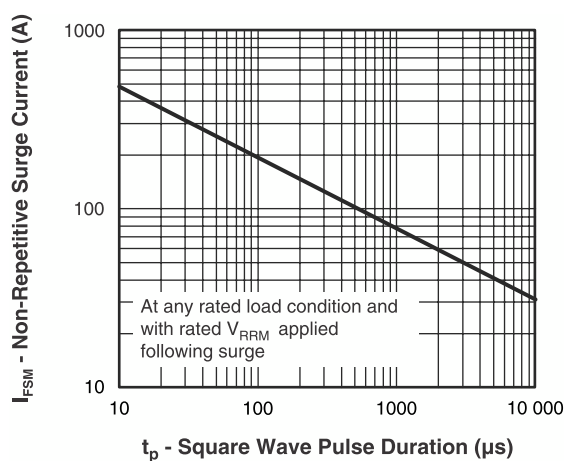


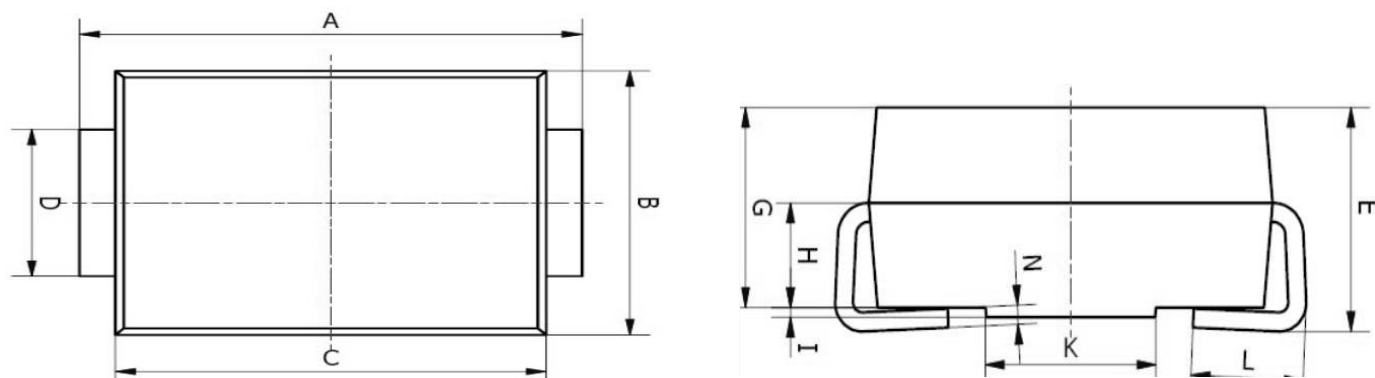
Fig. 7 - Maximum Peak Surge Forward Current vs. Pulse Duration

Note

- (1) Formula used: $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$;
 P_d = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
 P_{dREV} = Inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at $V_{R1} = 80\%$ rated V_R

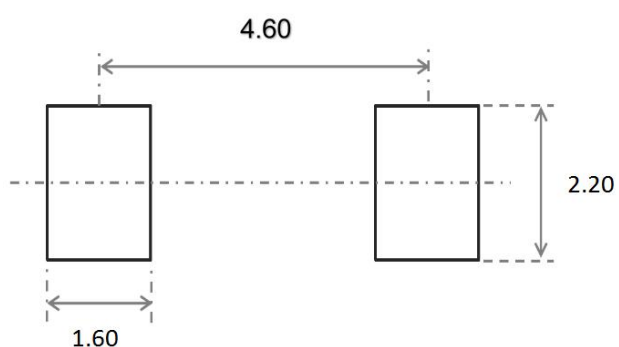
Schottky Rectifier Diodes

SMB Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	5.00	5.45	0.197	0.215
B	3.20	4.00	0.126	0.157
C	4.30	4.70	0.169	0.185
D	1.80	2.20	0.071	0.087
E	2.20	2.50	0.087	0.098
G	1.90	2.30	0.075	0.090
H	0.95	1.25	0.037	0.049
I	0.05	0.15	0.002	0.006
K	1.70	2.10	0.067	0.083
L	0.90	1.60	0.035	0.063
N	0.10	0.30	0.004	0.012

SMB Suggested Pad Layout



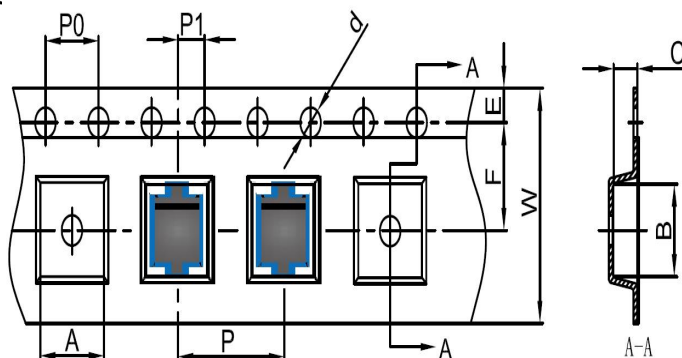
Note:

1. Controlling dimension: in millimeters
2. General tolerance: $\pm 0.05\text{mm}$
3. The pad layout is for reference purposes only

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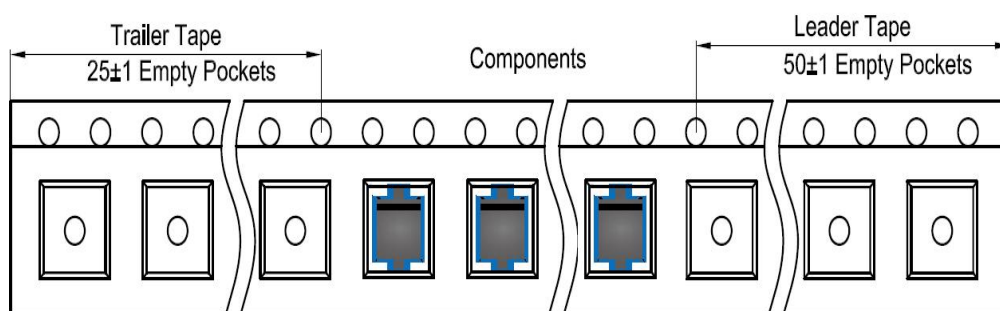
SMB Tape and Reel

SMB Embossed Carrier Tape

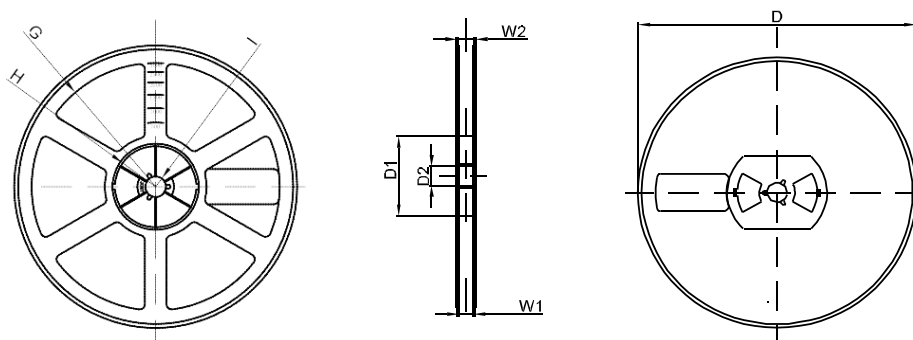


DIMENSIONS ARE IN MILLIMETER										
TYPE	A	B	C	d	E	F	P0	P	P1	W
SMB	4.10	5.50	2.58	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00
TOLERANCE	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1

SMB Tape Leader and Trailer



SMB Reel



DIMENSIONS ARE IN MILLIMETER								
REEL OPTION	D	D1	D2	G	H	I	W1	W2
13" DIA	Ø330	75.0	13.00	R165	R37.50	R6.50	12.40	17.60
TOLERANCE	±2	±1	±1	±1	±1	±1	±1	±1